1.Material:

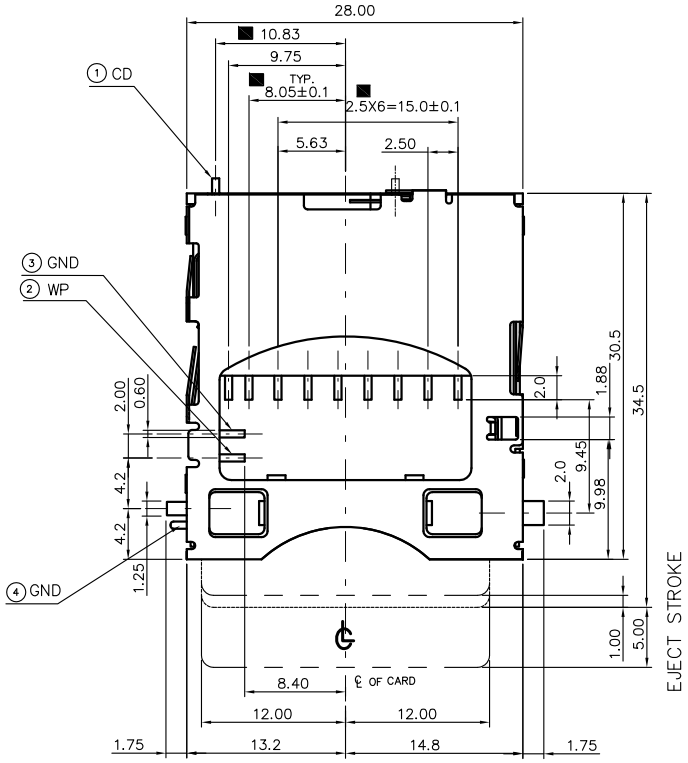
Insulator: LCP+30% G.F., UL 94V-0 Rated Color: Black
Contact: Phosphor Bronze , 0.25t

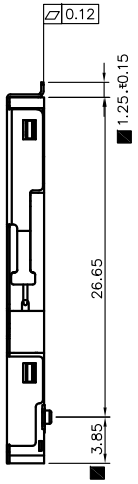
2.Plating:

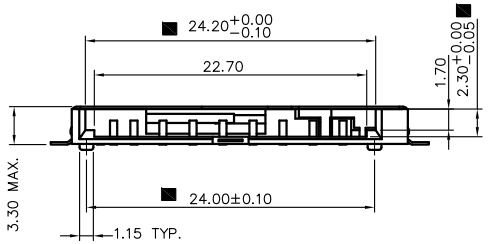
Contact Area: Gold plating over 50u"Nickel underplating.
Soldering Zone: 100%TIN over 50u" min. Ni underplate overall.
Au Contact Area: 10u" Gold Plating.

3.Inspection Dimension: ■ Critical

Note: 4.This soldering pad is optional and shall be grounding.







104G-T A A 0-R
1 2 3 4

1.Type
T:TOP Mount

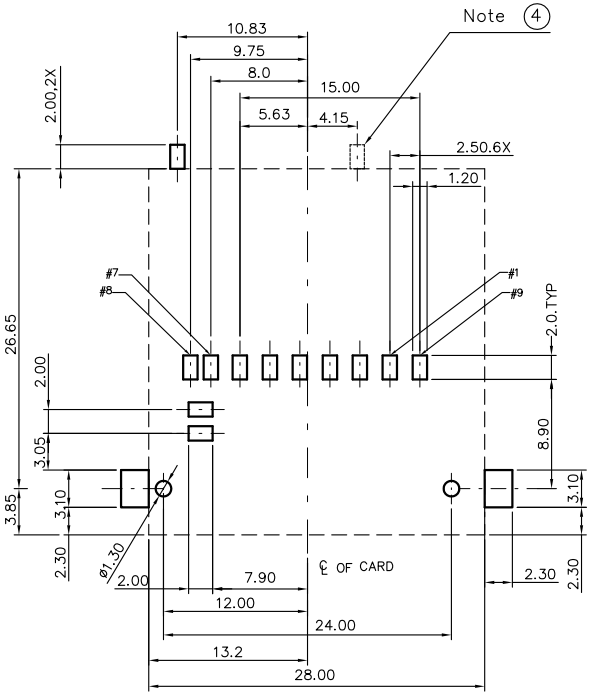
2.Contact Plating
A:10u"Gold Plating

3.Stand Off
A:0mm

4.ROHS

CARD DETECTION	
WITHOUT CARD	CARD INSERTED
① ④ ③ GND	① ④ ③ GND

WRITE PROTECT SWITCH	
WRITE PROTECTION LOCK	WRITE PROTECTION UNLOCK
② ④ ③ GND	② ④ ③ GND



RECOMMENDED P.C.B. LAYOUT

UNLESS OTHERWISE SPECIFIED TOLERANCE	
ANG.	±5°
0.	±
.0	±0.25
.00	±0.20

SCALE: AS SHOWED UNIT: mm

DRAWN willis 2007/1/9

CHECKED / /

APPROVED / /

SIZE A4 REV.

ATTEND TECHNOLOGY INC.
www.attend.com.tw

DRAWN NAME: SD Socket
Top Mount,Push-Push Type,w/Card Lock Function

PRODUCT NO. 104G-TAA0-R

FILE NAME: 104G-TAA0-R

REV.	DESCRIPTION	DATE